

RE

03-01-2000

NEC 99USFP447

:ET

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

Tab settings ⇨ ⇨ ⇨ ▼

To the Honorable Commissioner of Patent

101278190

Attached original documents or copy thereof.

## 1. Name of conveying party(ies):

Hitoshi Okamura

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other \_\_\_\_\_

Execution Date: January 28, 2000

## 2. Name and address of receiving party(ies):

Name: NEC CORPORATION

Internal Address: \_\_\_\_\_

Street Address: 7-1, Shiba 5-chome, Minato-ku

City: Tokyo State: JAPAN ZIP: \_\_\_\_\_

Additional name(s) & address(es) attached? ☐ Yes ☒ No

## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: January 28, 2000

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Norman P. Soloway

Internal Address: \_\_\_\_\_

Street Address: HAYES, SOLOWAY, HENNESSEY, GROSSMAN & HAGE  
175 Canal Street

City: Manchester State: NH ZIP: 03101

## 6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00

☒ Enclosed☐ Authorized to be charged to deposit account

## 8. Deposit account number:

08-1391

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

## 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Norman P. Soloway  
Name of Person Signing

Signature

February 14, 2000  
Date

Total number of pages (including cover sheet):

3

REEL: 010570 FRAME: 0953

ASSIGNMENT

FOREIGN - IN THE UNITED STATES OF AMERICA

I/we, HITOSHI OKAMURA

of Tokyo, Japan

having invented certain inventions and improvements in METHOD OF  
DESIGNING OF SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE IN SHORT TIME

and having executed an application for Letters Patent of the United  
States of America describing the same and based thereon on

January 28, ~~19~~2000, for good and valuable consideration, the  
receipt of which is hereby acknowledged, from NEC Corporation,

a Japanese corporation

having its principal place of business at

7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan

(hereinafter

called the Assignee), do hereby sell, assign and transfer unto the  
Assignee, its successors, and assigns our entire rights, title, and  
interest, in and to said invention in the United States of America,  
including all rights, title and interest in the above-mentioned  
application and any divisional, continuing or reissue application or  
applications, and any patent which may be issued on the said invention  
in the United States of America.

And for the same consideration, I/we do hereby agree that I/we  
will upon request execute any instrument which the Assignee may desire  
to carry this Assignment into effect and perfect the title transferred  
hereby or prosecute the above-mentioned application.

And I/we do hereby authorize the Commissioner of Patents and  
Trademarks of the United States of America to issue Letters Patent on  
the said application to the Assignee.

And I/we do hereby jointly and severally covenant for ourselves and for our legal representatives that I/we have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our rights, title, and interest in and to said inventions or any of them or any part thereof has not been otherwise encumbered by us, and that I/we have not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, I/we have hereunto set our hands and seals on the day and year hereinafter noted.

Sole or First  
Inventor's signature Hitoshi Okamura Date January 28, 2000  
Full name (typed or printed) HITOSHI OKAMURA

Witness: Hitoshi Ukai Witness: [Signature]  
Date: January 28, 2000 Date: January 28, 2000

Second Inventor's  
signature \_\_\_\_\_ Date \_\_\_\_\_  
Full name (typed or printed) \_\_\_\_\_

Witness: \_\_\_\_\_ Witness: \_\_\_\_\_  
Date: \_\_\_\_\_ Date: \_\_\_\_\_

Third Inventor's  
signature \_\_\_\_\_ Date \_\_\_\_\_  
Full name (typed or printed) \_\_\_\_\_

Witness: \_\_\_\_\_ Witness: \_\_\_\_\_  
Date: \_\_\_\_\_ Date: \_\_\_\_\_